

Solid State Tracking ***Emerging ideas from BRN studies***

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Introductory remarks

- ❑ General goal shared by BRN study and Snowmass: “accelerated development of cost-effective instrumentation with greatly improved sensitivity and performance” to facilitate ambitious physics program being currently laid out.
- ❑ To frame goals, decide to set Grand Challenges (or unifying principles):
 - ❑ Advance HEP detectors to new regimes of sensitivity
 - ❑ Using integration to enable scalability for HEP sensors
 - ❑ Build next-generation HEP detectors with **novel materials** and **advanced techniques**
 - ❑ Mastering **extreme environments** and **data rates** in HEP experiments
- ❑ Start with physics motivation (P5 science drivers) & match them with instrumentation R&D directions

Input drivers

1. Higgs and the Energy Frontier
2. Neutrino physics
3. Dark matter
4. Cosmic acceleration: Dark energy and inflation
5. Explore the Unknown

Higgs (e+e-)	$\sigma_{p_T}/p_T=0.2\%$, GeV $\frac{\sigma_{p_T}}{p_T^2} = 2 \times 10^{-5} / \text{GeV}$ central tracks $p_T > 100$ GeV Impact parameter resolution $\sigma_{r\phi} = \left(5 \oplus 15(p[\text{GeV} \sin^{3/2}(\vartheta)])^{-1} \right) \mu\text{m}$ Per track timing resolution 10 ps
Higgs (pp)	$\sigma_{p_T}/p_T=0.5\%$ central tracks $p_T < 100$ GeV+ above Per track timing resolution of 5ps Radiation tolerance to 300 MGy and $8 \times 10^{17} n_{eq}/\text{cm}^2$
New physics through flavor interactions	Medium term: timing 10-30 ps/hit in Si VTX detector 1—30 ps/track PID/calorimeter Medium term: Radiation tolerance $5 \times 10^{16} n_{eq}/\text{cm}^2$ Long term: Radiation tolerance $1 \times 10^{18} n_{eq}/\text{cm}^2$
CLFV	Low mass tracking with 20 ps/track timing resolution

Historical context

- Introduction of Si microstrip detectors in the early '80 was **transformative** (made possible studies of b and c at fixed target experiments, then at LEP, Tevatron & LHC cornerstone of the physics)
- Radiation hard hybrid pixel detectors **transformative** (granularity, radiation hardness, electronics integration)
- Developments in services and mechanics/cooling are **transformative** (e.g. CO₂ evaporative cooling) and they are become increasingly important

Priority research direction I – ps timing

Develop high spatial resolution pixel detectors with precise per-pixel time resolution to resolve individual interactions in high-collision-density environments

Thrust 1: Lepton colliders, requiring timing on the order of 10 ps; pixel pitch on the order of 10 microns

Thrust 2: Hadron colliders, requiring timing resolution down to 1 ps to achieve HL-LHC-like pileup, in a high radiation environment (up to fluences in the order of $10^{18}n_{\text{eq}}/\text{cm}^2$) [this thrust includes forward detector at pp machine]

Research directions

- Currently two sensor technologies being pursued:
 - LGADs – issue: loss of gain at fluence $>2 \times 10^{15} n_{eq}/cm^2$
 - 3D sensors – rad hard excellent: 80% charge collection efficiency at $3 \times 10^{16} n_{eq}/cm^2$ [150V bias], 20 ps time resolution TIMESPOC collaboration – issue VLSI capable of delivering this performance
- Future plans need to optimize not only sensor, but integrate sensor/readout electronics and surrounding services [**cooling, data transfer, power**]
- Monolithic pixel system incorporating timing may be a good starting point, but integration issues are still non-trivial

Priority research direction II: New materials

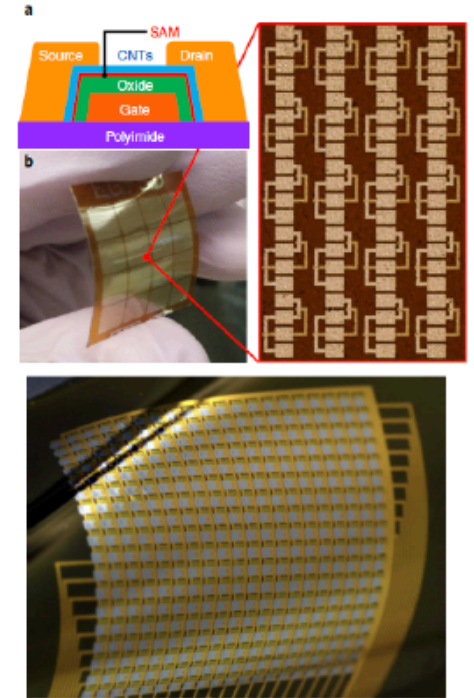
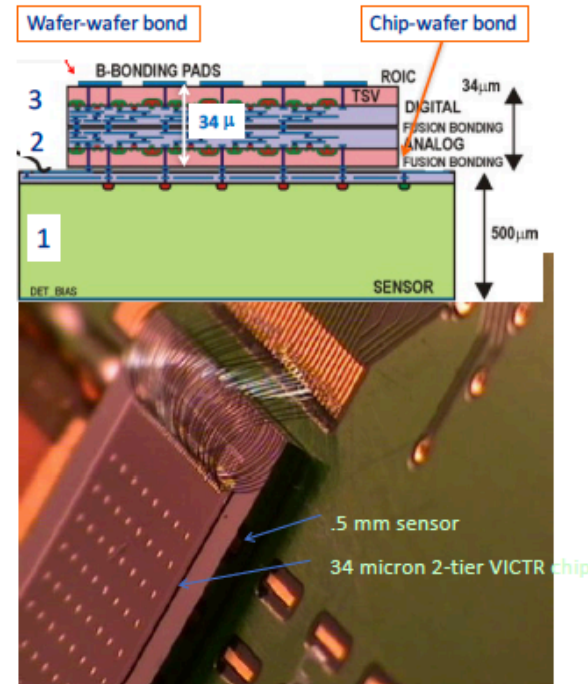
Adapt new materials for sensor (and electronics) development, and fabrication/integration techniques

Look for alternative materials to silicon, especially for extreme radiation environments

Develop electronics in conjunction with novel sensors, 3d integration

Research directions

- ❑ Alternatives to silicon for sensors (diamond, large-bandgap semiconductor, thin film material)
- ❑ Readout technologies matched to new sensor, integration of nanotechnology
- ❑ 3d vertical integration of multi-tier processing electronics and sensor.
- ❑ Overall material budget optimization



***Priority research direction III:
Scalable/irreducible mass tracking***

Realize scalable, irreducible mass trackers

Develop highly integrated, monolithic active sensors

Scaling of low-mass detector system

Adapt technologies to special applications

Research directions

❑ Ultimate goal realize a full-scale mass minimized tracker:

- ❑ Detector thinning (e.g. Alice)
- ❑ Efficient services
- ❑ New ideas coming from other fields

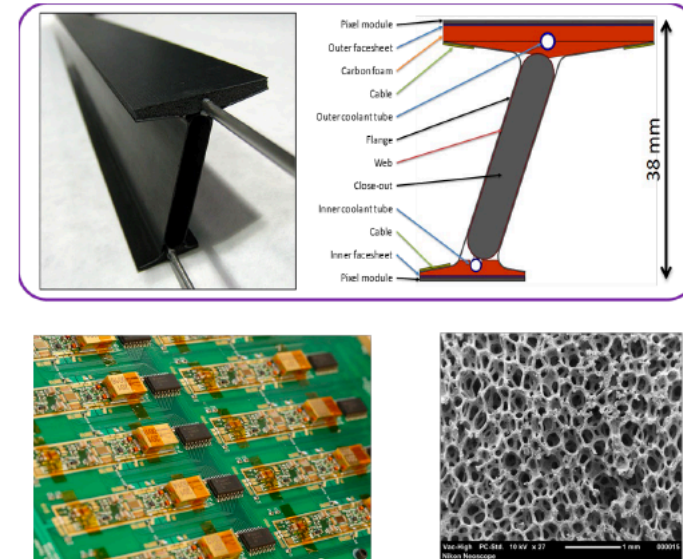


Figure 47: Top: Low mass I-beam structure designed to support two layers of pixel detectors in a cylindrical barrel geometry. Faces are made of high modulus, high conductivity carbon fiber, high thermal conductivity carbon foam fills the interior along with embedded cooling pipes carrying high pressure CO₂. Entire composite is bonded using a co-curing process. Bottom Right: Thermally conductive carbon foam developed in part through the DOE SBIR program with HEP. This foam, which is machinable, has a thermal conductivity of 30-40 W/m-C at 10% the density of solid carbon. It can be used as a low mass thermal conductor and heat spreader within composite tracker support structures. Bottom Left: Low mass power regulation and control hybrid being developed for a large collider tracker. Hybrid includes DCDC conversion, HV multiplexing and filter, and monitoring and control ASICs. To produce and test thousands of hybrids, circuits are assembled, tested, and burned-in on large panels.

Connection with other fields

- Astroparticle, medical, homeland security, engineering, and art

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Many interesting synergies to be exploited

Left: Graphic combining energy spectra measured by RToo scanner (© InsightART, 2019); Right: RToo scanning the painting Madonna and Child (© Jiří Lauterkranc, 2019). (Image: CERN)

Infrastructure needed

	Higgs and Energy Frontier	Neutrinos	Dark Matter	Cosmic Acceleration	Unknown
Irradiation, ionizing and non-ionizing	✓	✓			✓
Test Beams	✓	✓			✓
Test Stands at Ultra-low Temperature			✓	✓	✓
Calibration Facilities	✓	✓	✓	✓	✓
Low Background Materials and Assay		✓	✓		✓
Ultra-light Composites	✓				✓
Novel CCD Development			✓	✓	
Superconducting Detector and Device Foundry			✓	✓	
Microelectronics Engineering and Foundry Access	✓	✓	✓	✓	✓
Simulation Framework	✓	✓	✓	✓	✓

Table 23: Facility and capability needs for the five Science Drivers.